September 6, 2017

Media Alert: QuickLogic to Participate in 2017 SMIC Technology Symposium in Shanghai

SUNNYVALE, Calif., Sept. 06, 2017 (GLOBE NEWSWIRE) -- QuickLogic Corporation (NASDAQ:QUIK), a developer of ultra-low power multi-core voice-enabled SoCs, embedded FPGA IP, display bridge and programmable logic solutions has been invited to take part in the 2017 SMIC Technology Symposium in Shanghai.

Date: September 13, 2017
Venue: 3F Shanghai Hall, Kerry Hotel Pudong, Shanghai
Time: 8:30 a.m. to 5:00 p.m.

QuickLogic will demonstrate its ArcticPro™ eFPGA (embedded FPGA) IP evaluation board on the SMIC 40LL process. The ArcticPro eFPGA in the SMIC 40LL process gives designers the ability to add a high degree of post manufacturing design flexibility and enables them to address fragmented and/or rapidly evolving standards with a single device at extremely low power.

About QuickLogic
QuickLogic Corporation (NASDAQ:QUIK) enables OEMs to maximize battery life for highly differentiated, immersive user experiences with Smartphone, Wearable and IoT devices. QuickLogic delivers these benefits through industry leading ultra-low power customer programmable SoC semiconductor solutions, embedded software, and algorithms for always-on voice and sensor processing. The company's embedded FPGA initiative also enables SoC designers to easily implement post production changes, and increase revenue by providing hardware programmability to their end customers. For more information about QuickLogic, visit www.quicklogic.com.

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Code: QUIK-G

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